

## PATENT

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Chien-Ping HUANG

Serial No.: 09/685,818

Group No.: 2814

Filed: September 20, 2000

Examiner: Tran, T.

For: SEMICONDUCTOR PACKAGE FOR ENHANCING HEAT DISSIPATION

Attorney Docket No.: U 013803-1

Assistant Commissioner for Patents

Washington, D.C. 20231

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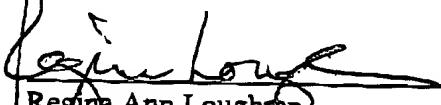
Letter to the Examiner

MAR 12 2002

TECHNOLOGY CENTER 2800

A substitute specification was filed for the above-identified application on March 11, 2002. Applicant's attorney hereby declares that no new matter is added therein.

Respectfully submitted,

  
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## CERTIFICATE OF MAILING/TRANSMISSION (37 CFR 1.8a)

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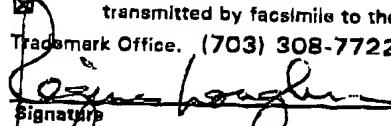
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